

SYSTEM AND A METHOD FOR PLATING OF A CONDUCTIVE PATTERN

Van Steenkiste et al.

Appl. No.: 09/744,465 Atty Docket: IMEC228.001APC

#7
attach

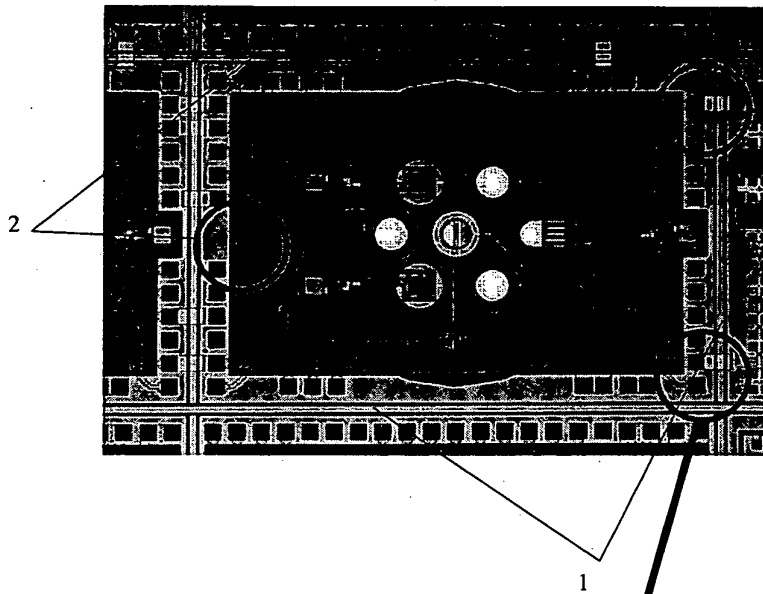


Figure 1

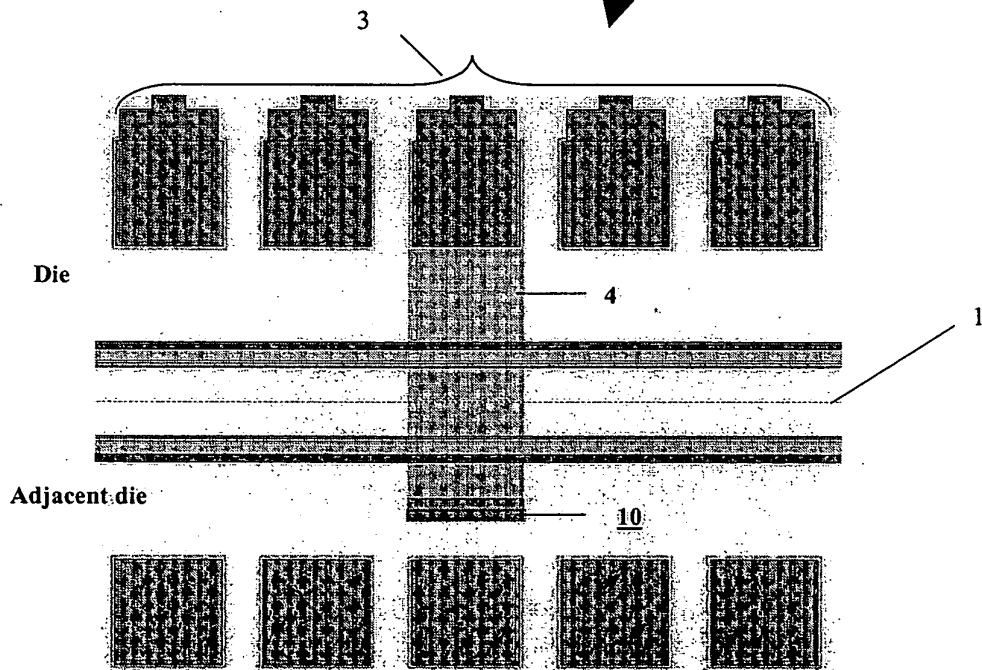


Figure 2



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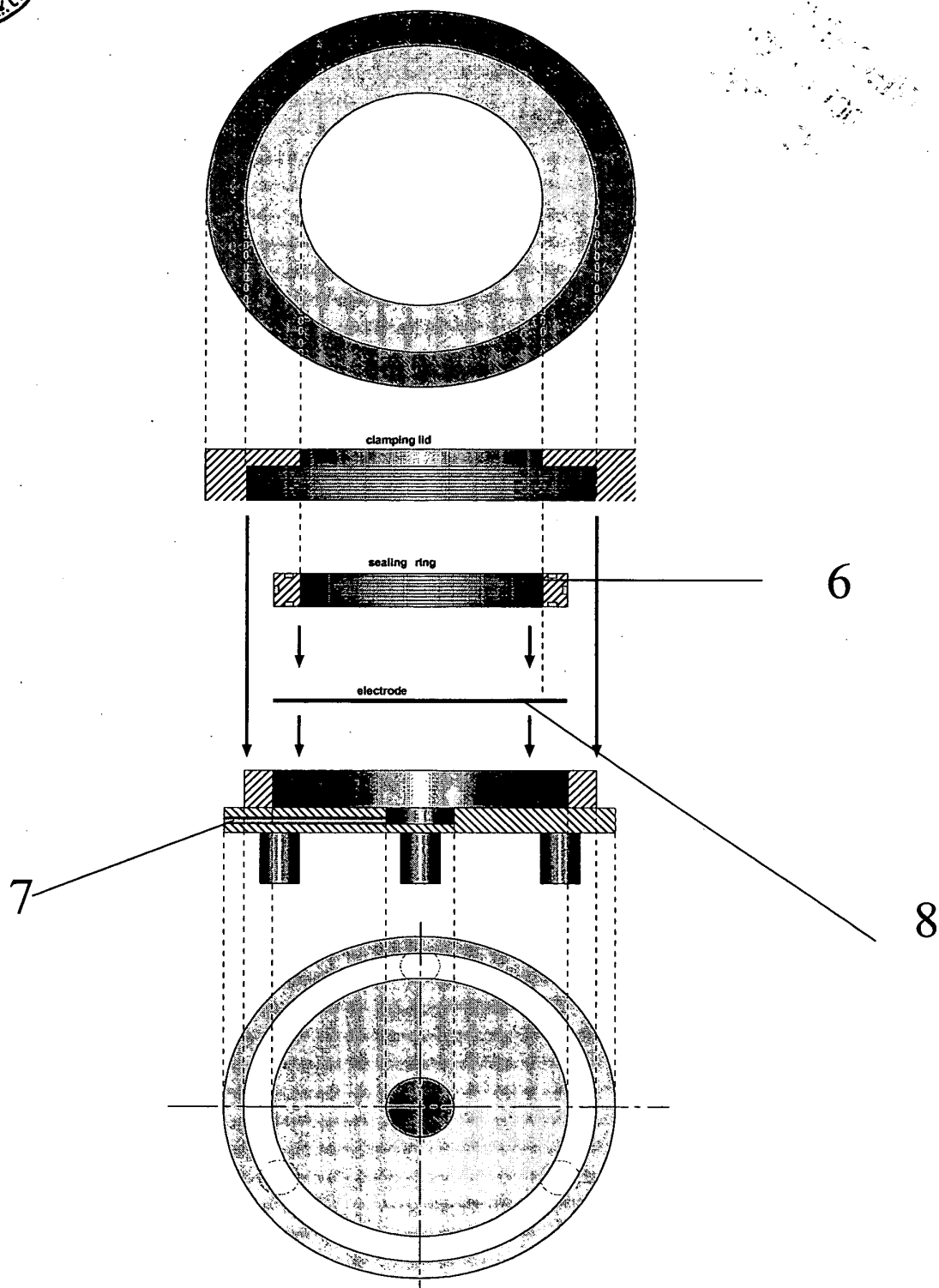


Figure 3

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PATTERN

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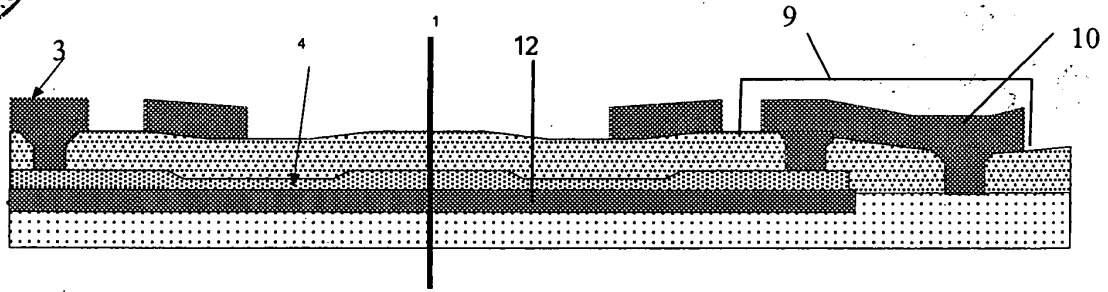
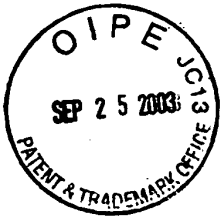


Figure 4